

FMW20N60S1HF

http://www.fujielectric.com/products/semiconductor/

FUJI POWER MOSFET

Super J-MOS series

N-Channel enhancement mode power MOSFET

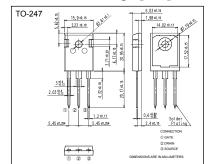
Features

Pb-free lead terminal RoHS compliant uses Halogen-free molding compound

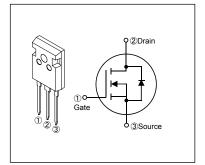
Applications

For switching

Outline Drawings [mm]



Equivalent circuit schematic



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks	
Duain Sauras Valtara	V _{DS}	600	V		
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V	
Continuous Drain Current		±20	Α	Tc=25°C Note*1	
Continuous Drain Current	I _D	±12.6	Α	Tc=100°C Note*1	
Pulsed Drain Current	IDP	±60	Α		
Gate-Source Voltage	V _{GS}	±30	V		
Repetitive and Non-Repetitive Maximum Avalanche Current	I AR	6.6	А	Note *2	
Non-Repetitive Maximum Avalanche Energy	Eas	472.2	mJ	Note *3	
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/μs	V _{DS} ≤ 600V	
Peak Diode Recovery dV/dt	dV/dt	15	kV/μs	Note *4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5	
Manimum Damas Disaination	Б	2.5	10/	T _a =25°C	
Maximum Power Dissipation	P _D	140	W	Tc=25°C	
Oncertion and Otamana Tamananatura and an	Tch	150	°C		
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C		

■ Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =250µA V _{DS} =V _{GS}		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μΑ
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =10A V _{GS} =10V		-	0.161	0.19	Ω
Gate resistance	R _G	f=1MHz, open drain		-	3.7	-	Ω

Note *1 : Limited by maximum channel temperature.

Note *2 : Teh≤150°C, See Fig.1 and Fig.2

Note *3 : Starting Teh=25°C, Ias=2A, L=216mH, Vbb=60V, Re=50Ω, See Fig.1 and Fig.2

Eas limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-Ip, -di/dt=100A/µs, Vpp≤400V, Tch≤150°C.

Note *5 : IF \leq -ID, dV/dt=15kV/ μ s, VDD \leq 400V, Tch \leq 150°C

http://www.fujielectric.com/products/semiconductor/

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g fs	I _D =10A V _{DS} =25V	8.5	17.5	-	S
Input Capacitance	Ciss	V _{DS} =10V	-	1470	-	
Output Capacitance	Coss	V _{GS} =0V	-	3120	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	280	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	90	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{GS} =0V V _{DS} =0480V ID=constant	-	305	-	
Turn-On Time	t _{d(on)}		-	22	-	
Turn-On Time	tr	V _{DD} =400V, V _{GS} =10V	-	40	-	ns
Turn-Off Time	t _{d(off)}	I₀=10A, R₀=27Ω See Fig.3 and Fig.4	-	162	-	
	tf		-	22	-	
Total Gate Charge	Q _G	V _{DD} =480V, I _D =20A V _{GS} =10V See Fig.5	-	48	-	
Gate-Source Charge	Q _{GS}		-	12.5	-	nC
Gate-Drain Charge	Q _{GD}		-	15	-	IIC IIC
Drain-Source crossover Charge	Qsw		-	8	-	

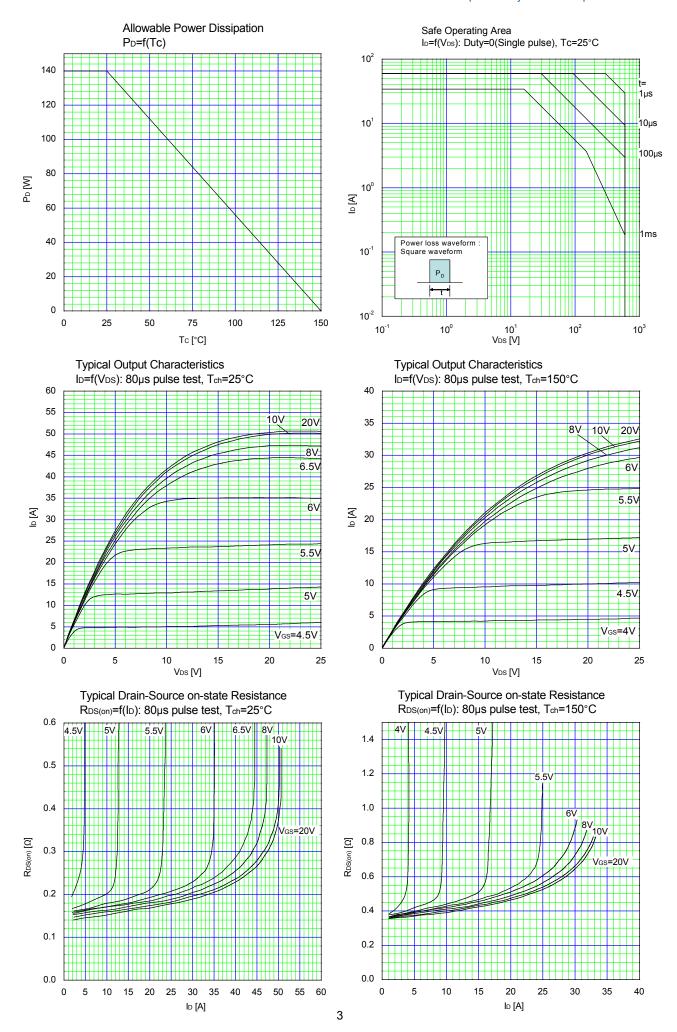
Note $^{\star}6$: $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% BVoss. Note $^{\star}7$: $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 80% BVoss.

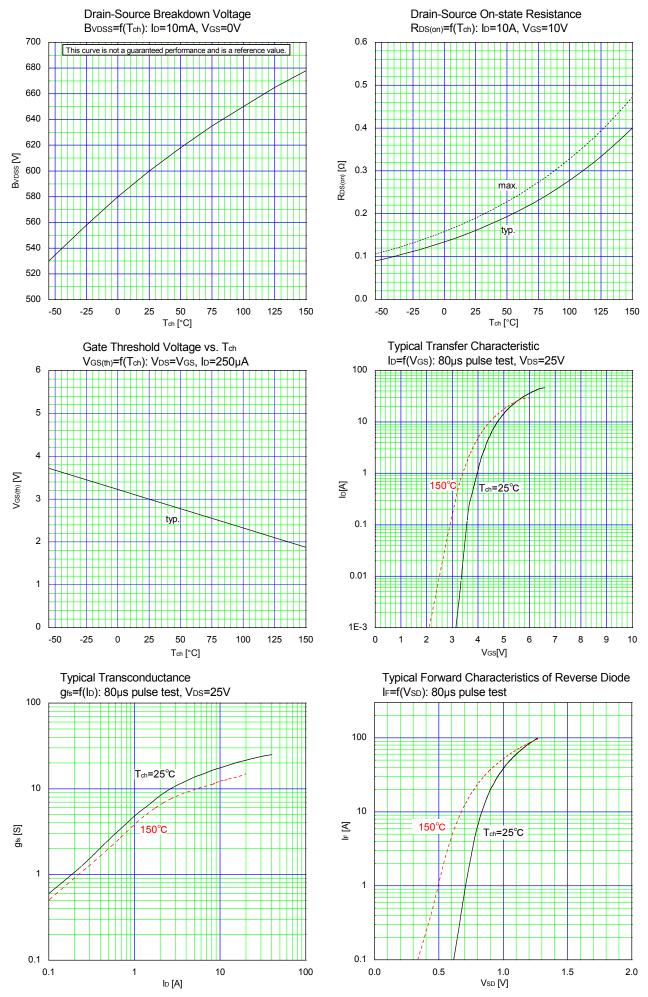
• Reverse Diode

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=6.02mH, T _{ch} =25°C See Fig.1 and Fig.2	6.6	-	-	Α
Diode Forward On-Voltage	V _{SD}	I _F =20A, V _{GS} =0V T _{ch} =25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	I _F =20A, V _{GS} =0V V _{DD} =400V -di/dt=100A/μs T _{ch} =25°C See Fig.6		370	-	ns
Reverse Recovery Charge	Qrr		-	6.2	-	μC
Peak Reverse Recovery Current	Irp		-	32	-	А

■ Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.89	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	50	°C/W

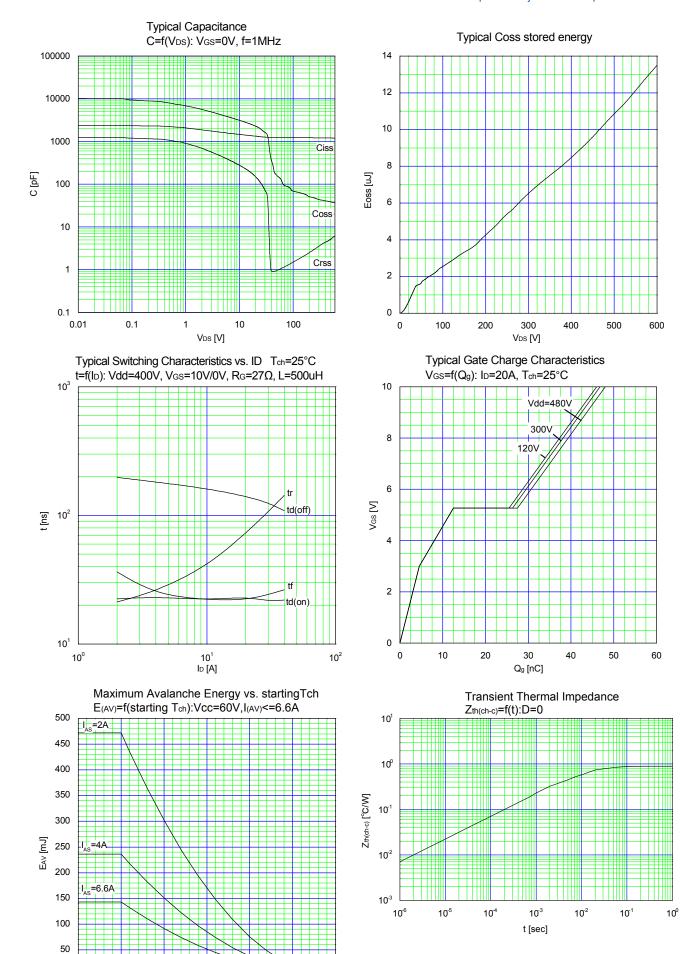




0 E

75

starting Tch [°C]



150

125

http://www.fujielectric.com/products/semiconductor/

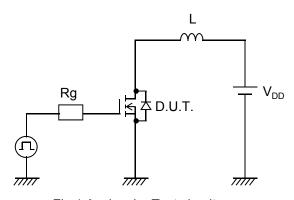


Fig.1 Avalanche Test circuit

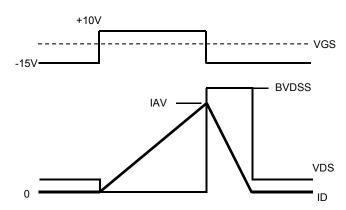


Fig.2 Operating waveforms of Avalanche Test

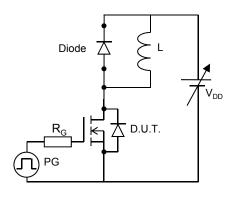


Fig.3 Switching Test circuit

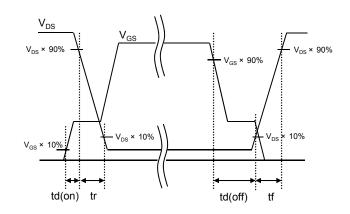


Fig.4 Operating waveform of Switching Test

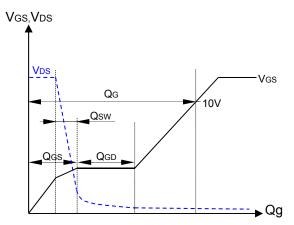


Fig.5 Operating waveform of Gate charge Test

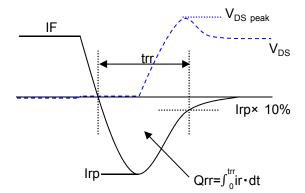
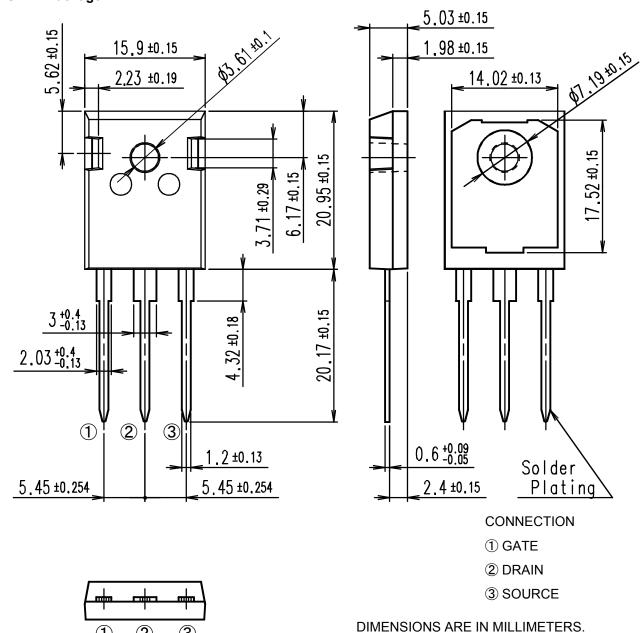


Fig.6 Operating waveform of Reverse recovery Test

Outview: TO-247 Package

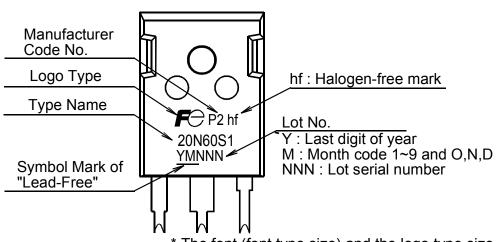


Marking

(1)

(2)

3



http://www.fujielectric.com/products/semiconductor/

WARNING

- 1. This Catalog contains the product specifications, characteristics, data, materials, and structures as of October 2015.

 The contents are subject to change without notice for specification changes or other reasons. When using a product listed in this Catalog, be sur to obtain the latest specifications.
- 2. All applications described in this Catalog exemplify the use of Fuji's products for your reference only. No right or license, either express or implied, under any patent, copyright, trade secret or other intellectual property right owned by Fuji Electric Co., Ltd. is (or shall be deemed) granted. Fuji Electric Co., Ltd. makes no representation or warranty, whether express or implied, relating to the infringement or alleged infringement of other's intellectual property rights which may arise from the use of the applications described herein.
- 3. Although Fuji Electric Co., Ltd. is enhancing product quality and reliability, a small percentage of semiconductor products may become faulty. When using Fuji Electric semiconductor products in your equipment, you are requested to take adequate safety measures to prevent the equipment from causing a physical injury, fire, or other problem if any of the products become faulty. It is recommended to make your design failsafe, flame retardant, and free of malfunction.
- 4. The products introduced in this Catalog are intended for use in the following electronic and electrical equipment which has normal reliability requirements.
- Computers
- OA equipment
- Communications equipment (terminal devices)
- Measurement equipment

- Machine tools
- Audiovisual equipment
- Electrical home appliances Personal e
- 5. If you need to use a product in this Catalog for equipment requiring higher reliability than normal, such as for the equipment listed below, it is imperative to contact Fuji Electric Co., Ltd. to obtain prior approval. When using these products for such equipment, take adequate measures such as a backup system to prevent the equipment from malfunctioning even if a Fuji's product incorporated in the equipment becomes faulty.
- Transportation equipment (mounted on cars and ships)
- Traffic-signal control equipment
- Emergency equipment for responding to disasters and anti-burglary devices
- Medical equipment

- Trunk communications equipment
- Gas leakage detectors with an auto-shut-off feature
- Safety devices
- 6. Do not use products in this Catalog for the equipment requiring strict reliability such as the following and equivalents to strategic equipment (without limitation).
- Space equipmentSubmarine repeater equipment
- Aeronautic equipment
- Nuclear control equipment
- 7. Copyright ©1996-2015 by Fuji Electric Co., Ltd. All rights reserved.

No part of this Catalog may be reproduced in any form or by any means without the express permission of Fuji Electric Co., Ltd.

8. If you have any question about any portion in this Catalog, ask Fuji Electric Co., Ltd. or its sales agents before using the product.

Neither Fuji Electric Co., Ltd. nor its agents shall be liable for any injury caused by any use of the products not in accordance with instructions set forth herein.